

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC7MBL3245SFT, TC7MBL3245SFK

Low Voltage/Low Capacitance Octal Bus Switch

The TC7MBL3245S provides eight bits of low- voltage, high-speed bus switching in a standard '245 device pinout. The low ON-resistance of the switch allows connections to be made with minimal propagation delay and while maintaining CMOS low power dissipation.

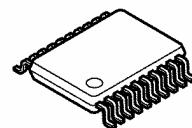
The device comprises a single 8-bit switch. When output enable (\overline{OE}) is low, the switch is on and port A is connected to port B. When \overline{OE} is high, the switch is open and a high-impedance state exists between the two ports.

All inputs are equipped with protection circuits to guard against static discharge.

Features

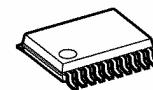
- Operating voltage: $V_{CC} = 1.65\sim3.6$ V
- Low capacitance: $C_{I/O} = 12$ pF Switch On (typ.) @3 V
- Low on resistance: $RON = 9$ Ω (typ.) @3 V
- ESD performance: Machine model $\geq \pm 200$ V
Human body model $\geq \pm 2000$ V
- Power down protection for inputs (\overline{OE} input only)
- Package: TSSOP20, VSSOP (US20)
- Pin compatible with the 74xx245 type

TC7MBL3245SFT



TSSOP20-P-0044-0.65A

TC7MBL3245SFK

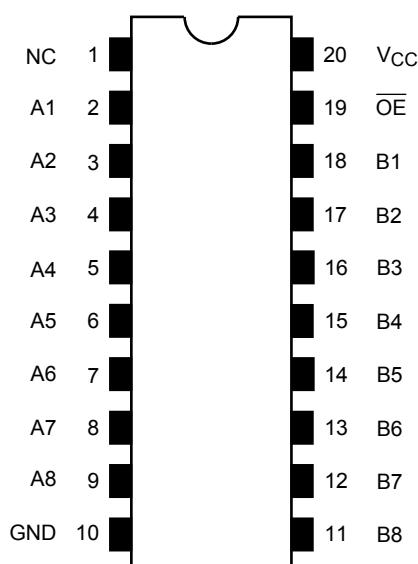


VSSOP20-P-0030-0.50

Weight

| | |
|----------------------|-----------------|
| TSSOP20-P-0044-0.65A | : 0.08 g (typ.) |
| VSSOP20-P-0030-0.50 | : 0.03 g (typ.) |

Pin Assignment (top view)

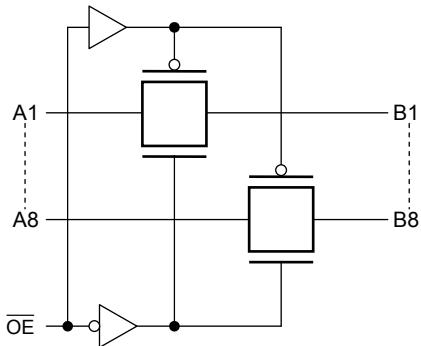


NC-No Internal Connection

Truth Table

| Inputs | Function |
|-----------|-----------------|
| <u>OE</u> | |
| L | A port = B port |
| H | Disconnect |

System Diagram



Absolute Maximum Ratings (Note)

| Characteristic | Symbol | Rating | Unit | |
|---------------------------------|-----------------------------------|----------------------------|------|----|
| Power supply range | V _{CC} | -0.5~4.6 | V | |
| Control pin input voltage | V _{IN} | -0.5~4.6 | V | |
| Switch terminal I/O voltage | V _S | -0.5~V _{CC} + 0.5 | V | |
| Clump diode current | Control input pin | I _{IK} | -50 | mA |
| | Switch terminal | | ±50 | mA |
| Switch I/O current | I _S | 50 | mA | |
| Power dissipation | P _D | 180 | mW | |
| DC V _{CC} /GND current | I _{CC} /I _{GND} | ±100 | mA | |
| Storage temperature | T _{stg} | -65~150 | °C | |

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Operating Ranges (Note)

| Characteristic | Symbol | Rating | Unit |
|---------------------------|------------------|-------------------|------|
| Power supply voltage | V _{CC} | 1.65~3.6 | V |
| Control pin input voltage | V _{IN} | 0~3.6 | V |
| Switch I/O voltage | V _S | 0~V _{CC} | V |
| Operating temperature | T _{opr} | -40~85 | °C |
| Input rise and fall time | dt/dv | 0~10 | ns/V |

Note: The operating ranges must be maintained to ensure the normal operation of the device.

Electrical Characteristics

DC Characteristics (Ta = -40~85°C)

| Parameter | | Symbol | Test Condition | V _{CC} (V) | Min | Typ. | Max | Unit |
|--|-----------------|------------------|--|-----------------------|----------|------|-----|-----------------------|
| Input voltage | | | | | | | | |
| "H" level | V _{IH} | — | 1.65~3.6 | 0.7 × V _{CC} | — | — | | |
| "L" level | | | V _{IL} | — | 1.65~3.6 | — | — | 0.3 × V _{CC} |
| Input leakage current | | I _{IN} | V _{IN} = 0~3.6V | 1.65~3.6 | — | ±1.0 | | |
| Power off leakage current | | I _{OFF} | OĒ | = 0~3.6 V | 0 | — | — | 1.0 |
| Off-state leakage current (switch off) | | I _{SZ} | A, B = 0~V _{CC} , OĒ = V _{CC} | | 1.65~3.6 | — | — | ±1.0 |
| On resistance (Note2) | | R _{ON} | V _{IS} = 0 V, I _S = 30 mA (Note1) | | 3.0 | — | 9 | 13 |
| | | | V _{IS} = 3.0 V, I _S = 30 mA (Note1) | | 3.0 | — | 15 | 20 |
| | | | V _{IS} = 2.4 V, I _S = 15 mA (Note1) | | 3.0 | — | 19 | 27 |
| | | | V _{IS} = 0 V, I _S = 24 mA (Note1) | | 2.3 | — | 10 | 16 |
| | | | V _{IS} = 2.3 V, I _S = 24 mA (Note1) | | 2.3 | — | 17 | 24 |
| | | | V _{IS} = 2.0 V, I _S = 15 mA (Note1) | | 2.3 | — | 21 | 30 |
| Increase in I _{CC} per input | | I _{CC} | V _{IN} = V _{CC} or GND, I _{OUT} = 0 | | 3.6 | — | — | 10 |
| | | | | | | | | μA |

Note1: All typical values are at Ta=25°C.

Note2: Measured by the voltage drop between A and B pins at the indicated current through the switch.
On resistance is determined by the lower of the voltages on the two (A or B) pins.

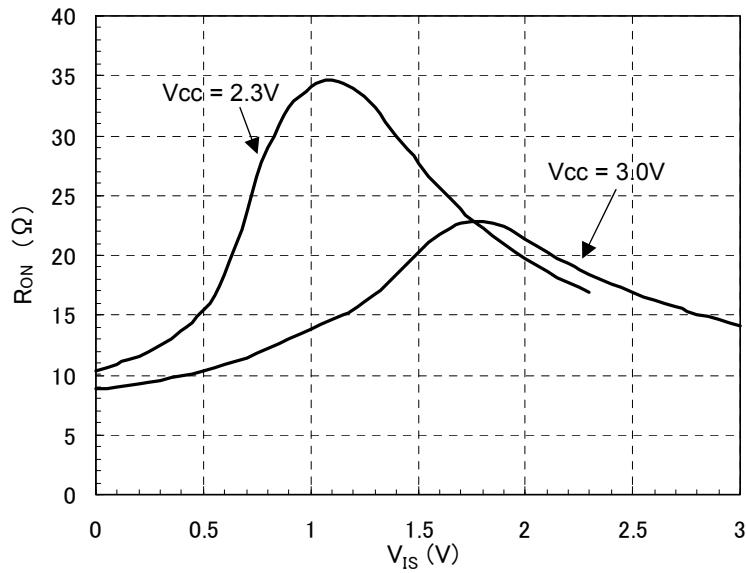
AC Characteristics (Ta = -40~85°C)

| Characteristics | Symbol | Test Condition | V _{CC} (V) | Min | Max | Unit |
|---------------------|--------------------------------------|--------------------|---------------------|-----|-----|------|
| | | | | | | |
| Output disable time | t _{pLZ} t _{pHZ} | Figure 1, Figure 2 | 3.3 ± 0.3 | — | 6 | ns |
| | | | | — | 7 | |
| | | | | — | 11 | |
| Output disable time | t _{pLZ} t _{pHZ} | Figure 1, Figure 2 | 3.3 ± 0.3 | — | 6 | ns |
| | | | | — | 7 | |
| | | | | — | 11 | |

Capacitive Characteristics (Ta = 25°C)

| Characteristics (Note) | Symbol | Test Condition | V _{CC} (V) | Typ. | Unit |
|-------------------------------|------------------|------------------------------------|---------------------|------|------|
| | | | | | |
| Control pin input capacitance | C _{IN} | | 3.0 | 3 | pF |
| Switch terminal capacitance | C _{I/O} | OĒ = V _{CC} (switch off) | 3.0 | 6 | pF |
| | | OĒ = GND (switch on) | 3.0 | 12 | pF |

Note : This parameter is guaranteed by design

R_{ON} Characteristic (typ.) Ta=25°C

AC Test Circuit

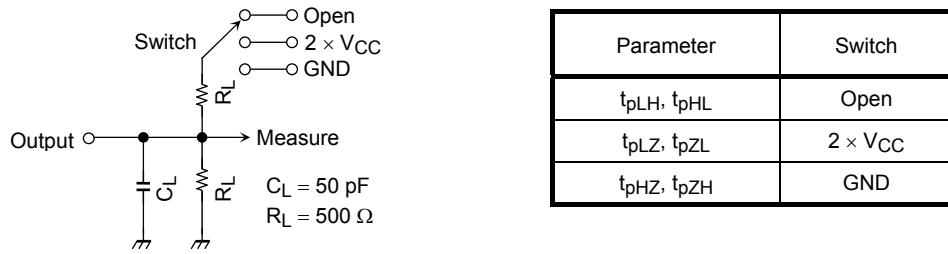
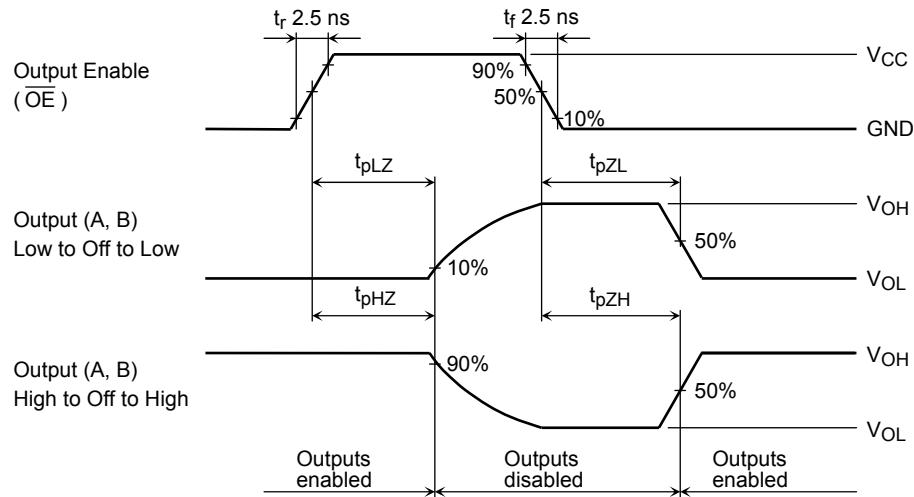


Figure 1

AC Waveform

Figure 2 t_{pLZ}, t_{pHZ}, t_{pZL}, t_{pZH}

Rise and Fall Times (tr / tf) of the TC7MBL3245S I/O Signals

The tr(out) and tf(out) values of the output signals are affected by the CR time constant of the input, which consists of the switch terminal capacitance ($C_{I/O}$) and the on-resistance (R_{ON}) of the input.

In practice, the tr(out) and tf(out) values are also affected by the circuit's capacitance and resistance components other than those of the TC7MBL3245S.

The tr / tf (out) values can be approximated as follows. (Figure 4 shows the test circuit.)

$$tr / tf \text{ out (approx)} = - (C_{I/O} + C_L) \cdot (R_{DRIVE} + R_{ON}) \cdot \ln (((V_{OH} - V_{OL}) - V_M) / (V_{OH} - V_{OL}))$$

where, R_{DRIVE} is the output impedance of the previous-stage circuit.

Calculation example:

$$tr \text{ out (approx)} = - (12 + 15) \cdot 10^{-12} \cdot (120 + 9) \cdot \ln (((3.0 - 0) - 1.5) / (3.0 - 0)) \\ \approx 2.4 \text{ ns}$$

Calculation conditions:

$V_{CC} = 3.0 \text{ V}$, $C_L = 15 \text{ pF}$, $R_{DRIVE} = 120 \Omega$ (output impedance of the previous IC), $V_M = 1.5 \text{ V} (V_{CC} / 2)$

Output of the previous IC = digital (i.e., high-level voltage = V_{CC} ; low-level voltage = GND)

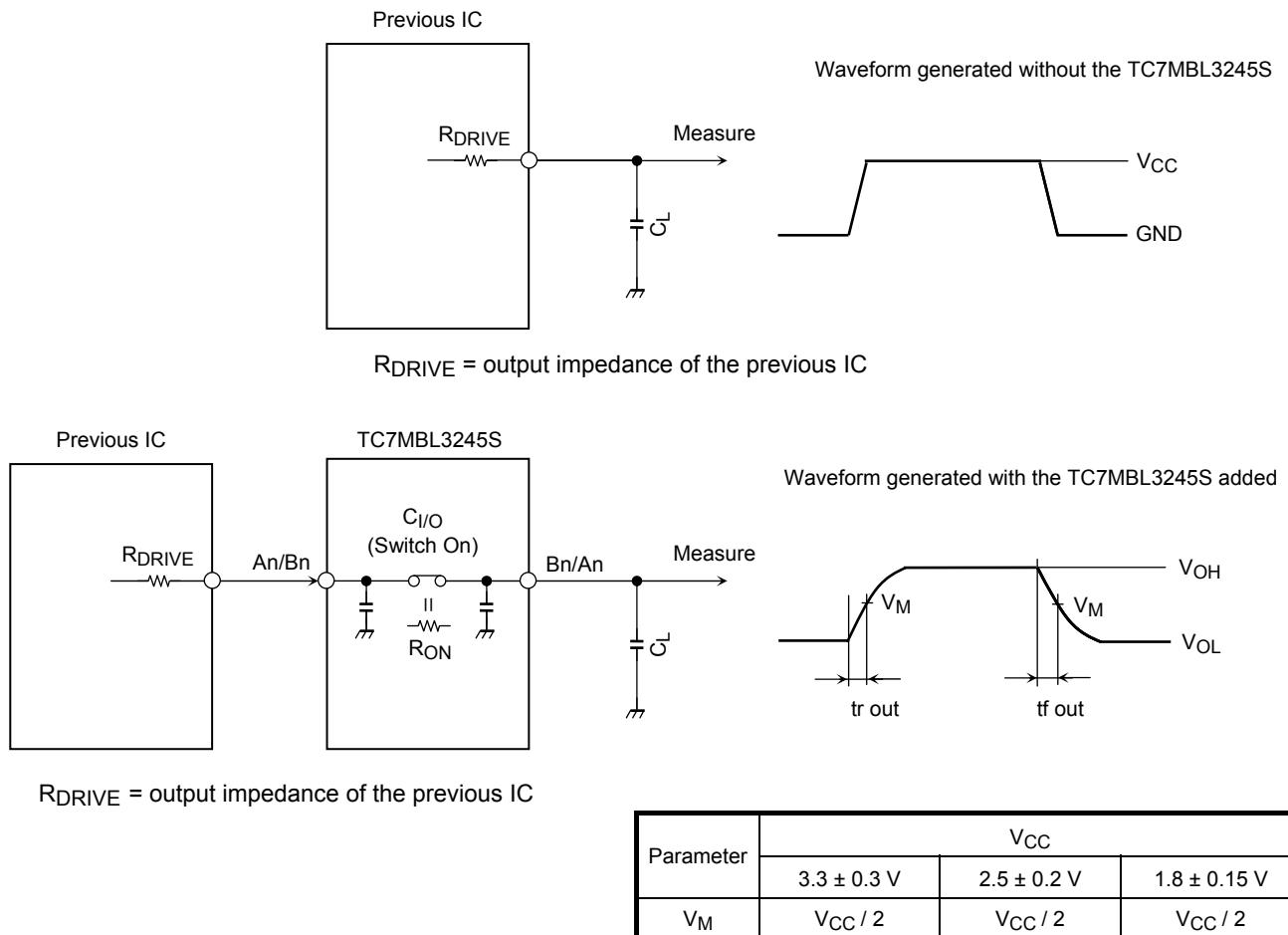
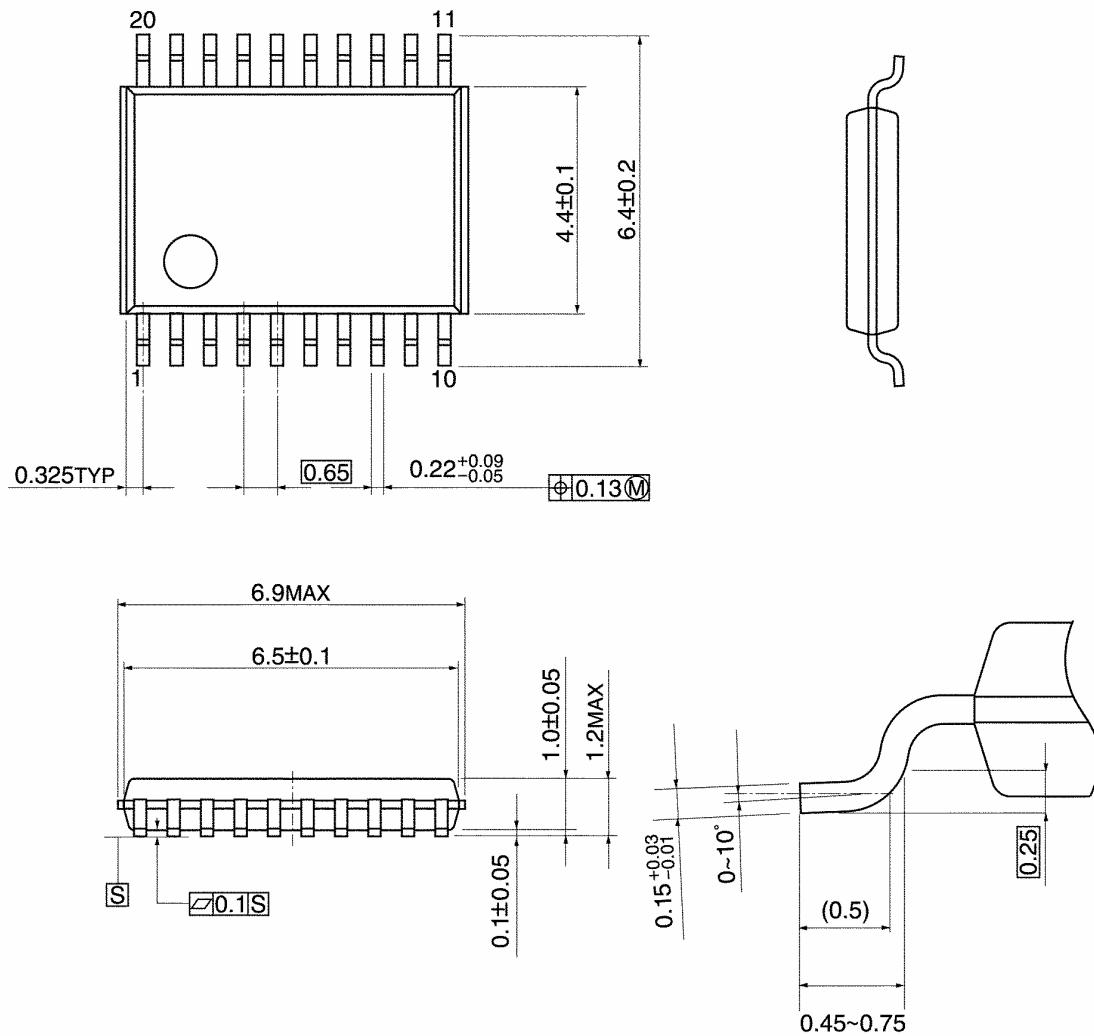


Figure 3 Test Circuit

Package Dimensions

TSSOP20-P-0044-0.65A

Unit: mm

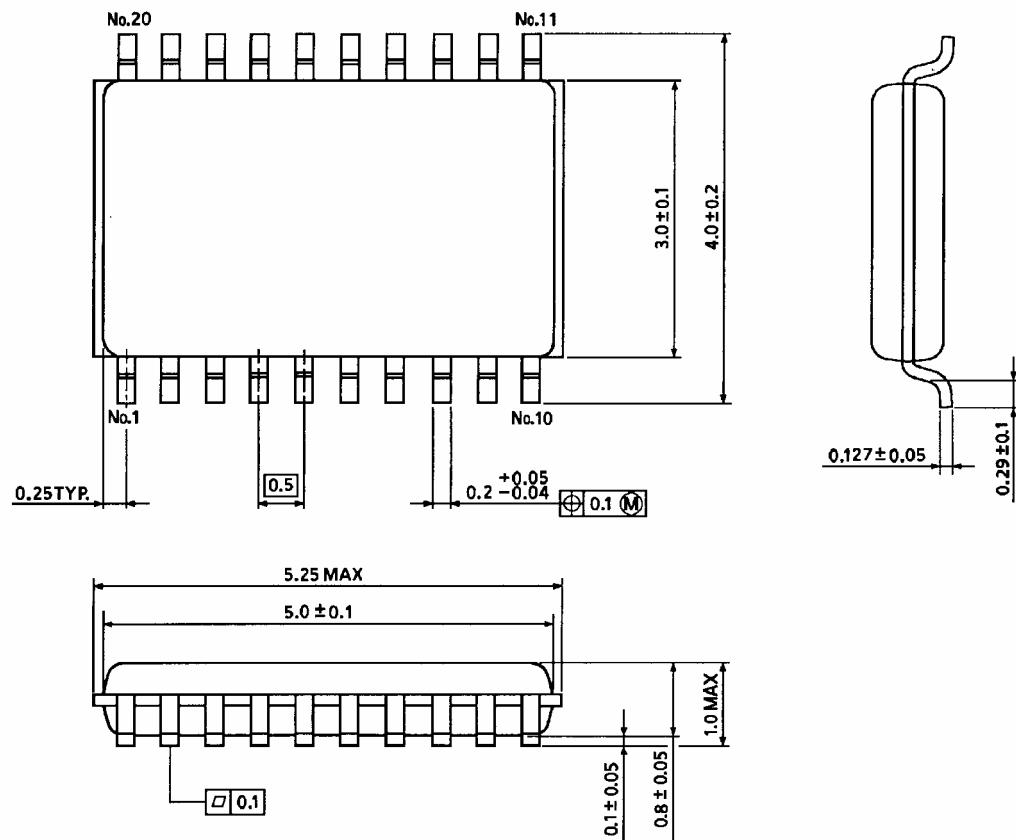


Weight: 0.08g (typ.)

Package Dimensions

VSSOP20-P-0030-0.50

Unit : mm



Weight: 0.03g (typ.)

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20070701-EN

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